

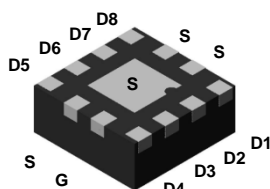
Features

- Low Gate Charge
- $R_{DS(ON)}$: 280m Ω @ $V_{GS} = 4.5V$ (Single MOSFET)
- 8 N-Channel MOSFET in 1 Device
- Common Source
- Small Footprint 1.5mm x 1.5mm
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

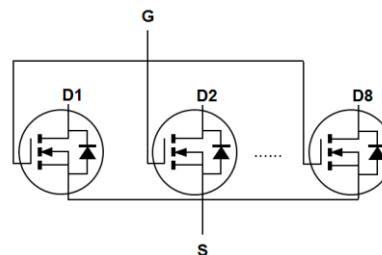
Mechanical Data

- Case: U-QFN1515-12
- Case Material - Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208③
- Terminal Connections: See Diagram
- Weight: 0.004 grams (Approximate)

U-QFN1515-12



Bottom View



Equivalent Circuit

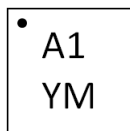
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1250UFEL-7	U-QFN1515-12	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

U-QFN1515-12



A1 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: B = 2014)
M = Month (ex: 8 = August)

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020	2021
Code	B	C	D	E	F	G	H	I

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	12	V
Gate-Source Voltage	V _{GSS}	±8	V
Drain Current (Note 6) Continuous	I _D	2.0	A
		1.6	
Pulsed Drain Current (Note 7)	I _{DM}	10	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.66	W
Total Power Dissipation (Note 6)	P _D	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	177	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	100	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

- Notes:
5. Device mounted on 1"x1", FR-4 PC board with minimum recommended pad layout, and test with single MOSFET.
 6. Device mounted on 1"x1", FR-4 PC board with 2 oz. copper, and test with single MOSFET.
 7. Repetitive Rating, pulse width limited by junction temperature, and test with single MOSFET.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
STATIC CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	12	—	—	V	I _D = 250μA, V _{GS} = 0V
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 12V, V _{GS} = 0V
Gate-Body Leakage Current	I _{GSS}	—	—	±100	nA	V _{DS} = 0V, V _{GS} = ±8V
Gate Threshold Voltage	V _{GS(TH)}	0.4	—	1	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance (Note 8)	R _{DS(ON)}	—	280	450	mΩ	V _{GS} = 4.5V, I _D = 0.2A
		—	360	550	mΩ	V _{GS} = 2.5V, I _D = 0.1A
Forward Transfer Admittance	Y _{FS}	—	1	—	S	V _{DS} = 6V, I _D = 0.2A
Diode Forward Voltage (Note 8)	V _{SD}	—	0.8	1.0	V	I _S = 0.2A, V _{GS} = 0V
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	—	146	190	pF	V _{DS} = 6V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	C _{oss}	—	10	15	pF	
Reverse Transfer Capacitance	C _{rss}	—	8	13	pF	
Gate Resistance	R _G	—	2.4	—	Ω	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz
SWITCHING CHARACTERISTICS (Note 9)						
Total Gate Charge	Q _g	—	1.3	1.9	nC	V _{GS} = 4.5V, V _{DS} = 6V, I _D = 0.2A
Gate-Source Charge	Q _{gs}	—	0.3	—	nC	
Gate-Drain Charge	Q _{gd}	—	0.1	—	nC	
Turn-On Delay Time	t _{D(ON)}	—	1.9	2.7	nS	V _{DD} = 6V, V _{GS} = 4.5V, R _L = 22Ω, R _G = 6Ω
Turn-On Rise Time	t _R	—	1.3	—	nS	
Turn-Off Delay Time	t _{D(OFF)}	—	7.5	11	nS	
Turn-Off Fall Time	t _F	—	1.0	—	nS	

- Notes:
8. Test pulse width t = 300ms, test with single MOSFET.
 9. Guaranteed by design with single MOSFET, not subject to production testing.

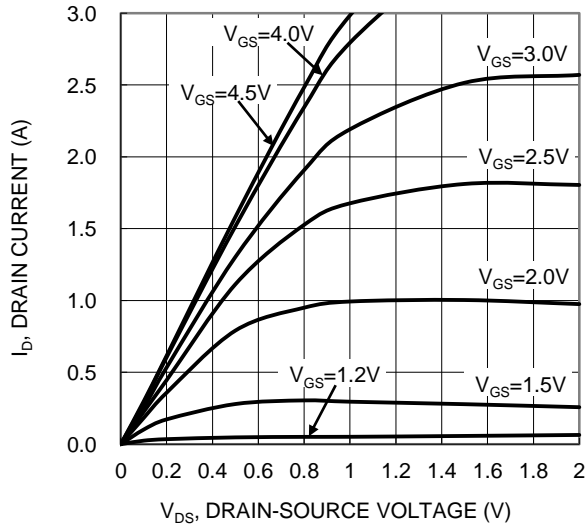


Figure 1. Typical Output Characteristic

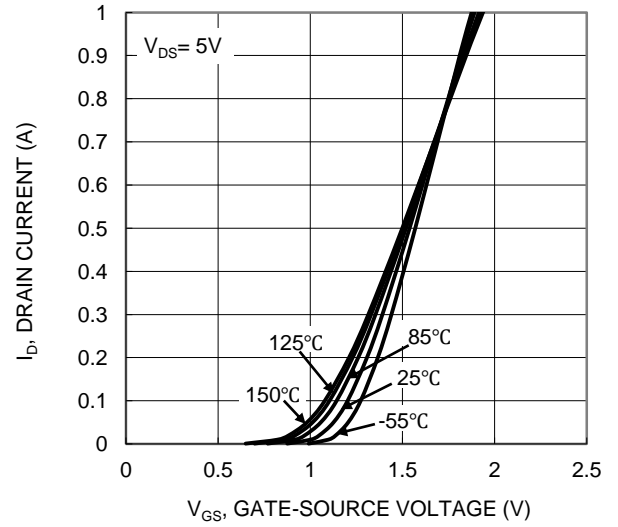


Figure 2. Typical Transfer Characteristic

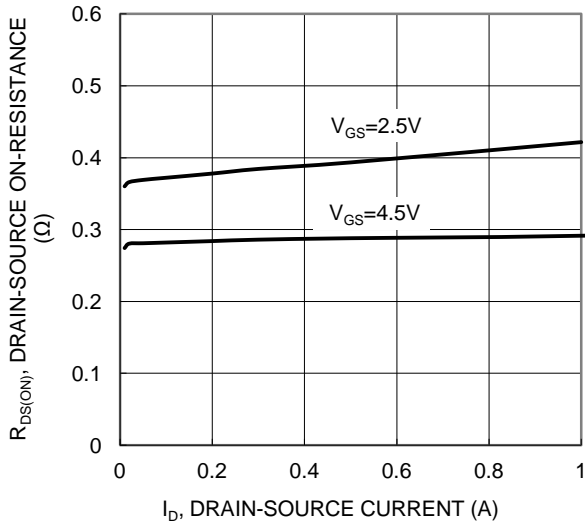


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

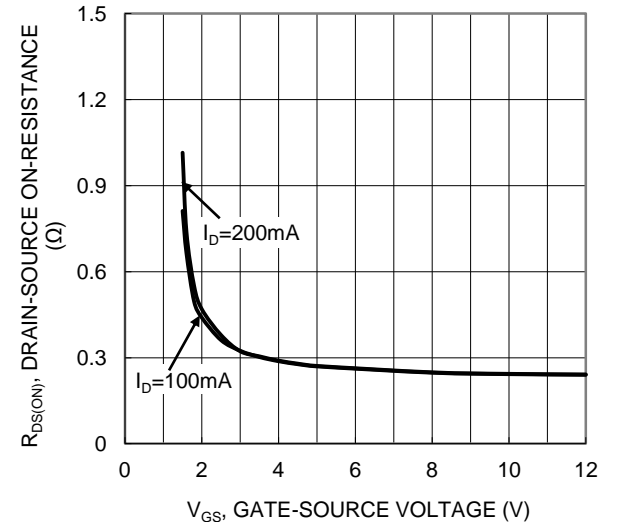


Figure 4. Typical Transfer Characteristic

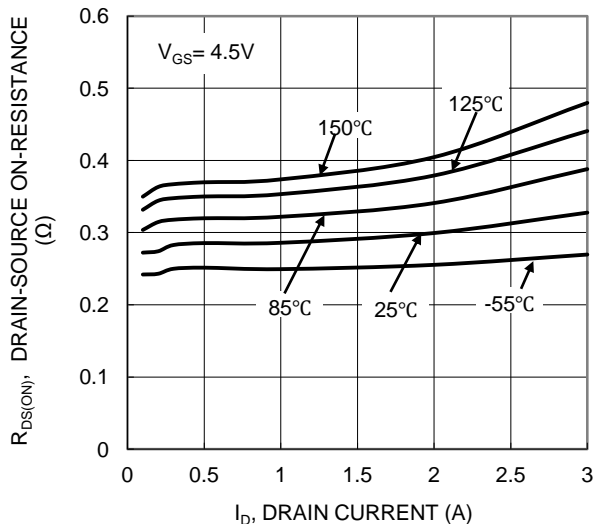


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

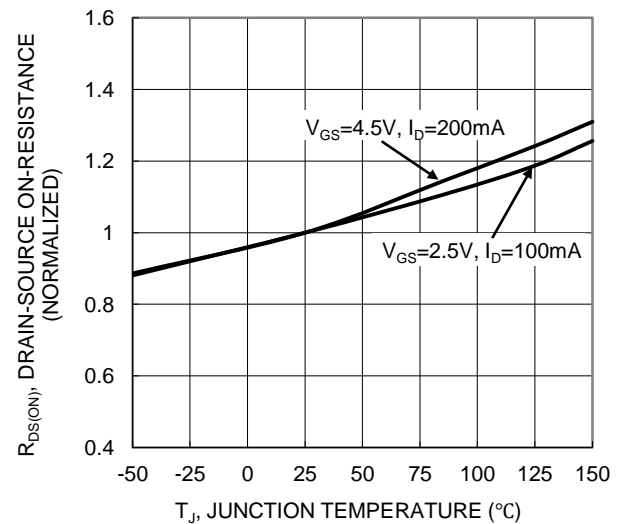
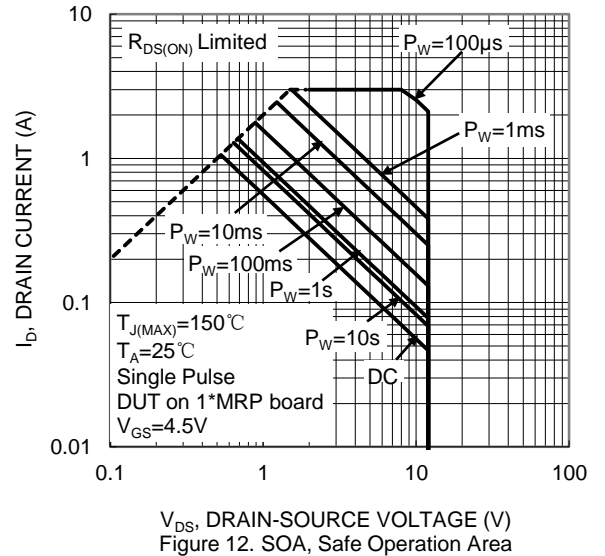
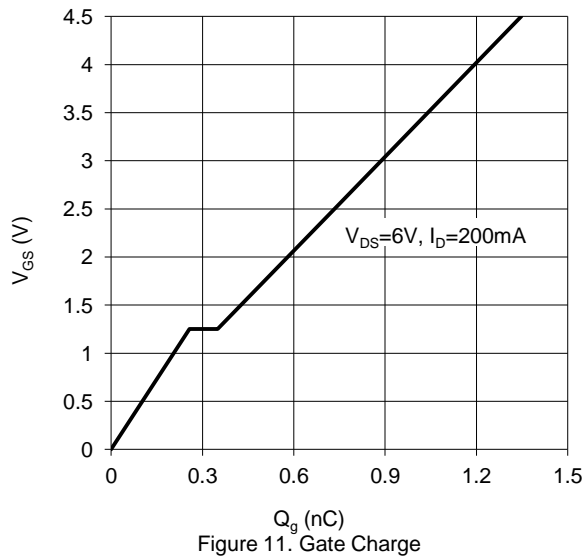
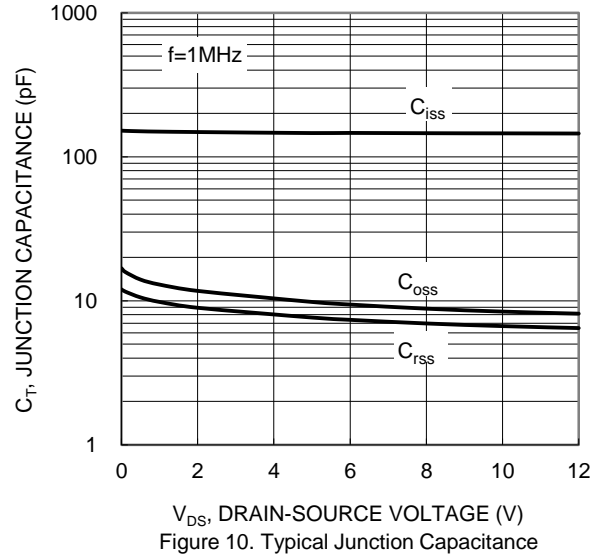
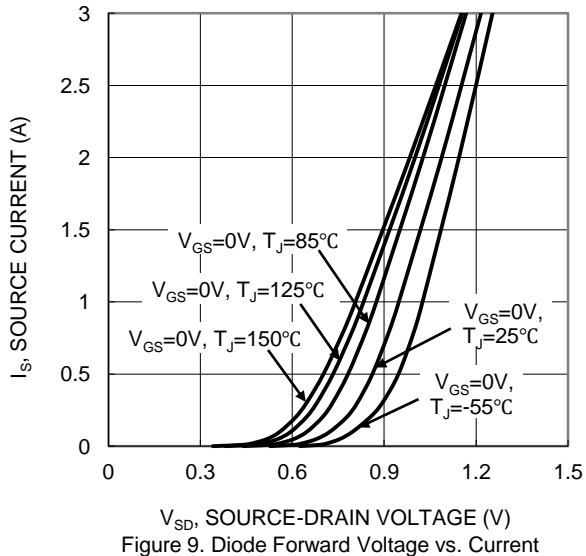
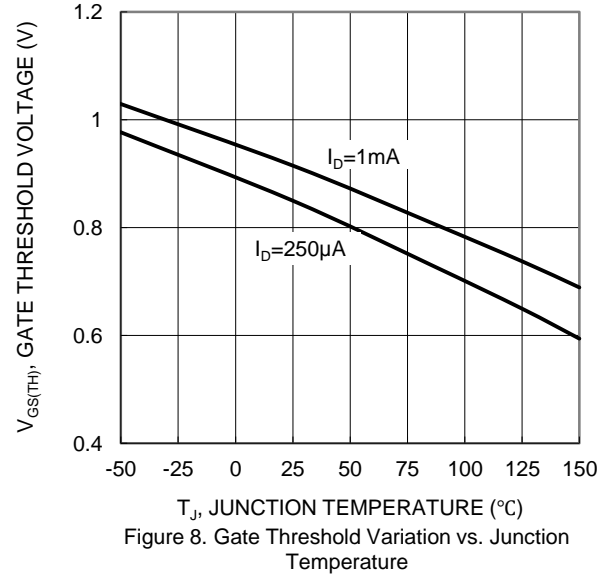
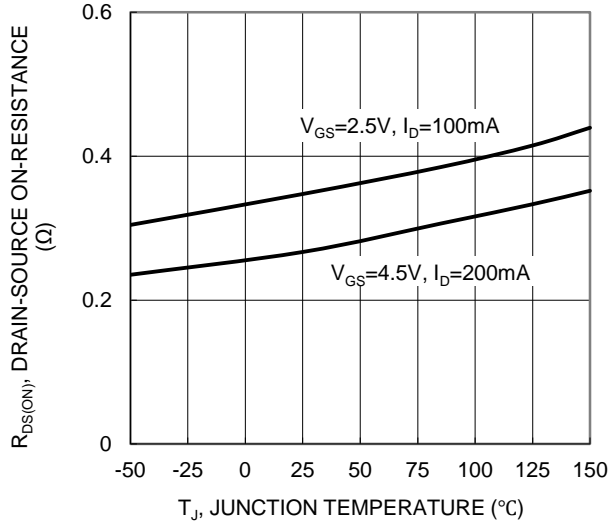
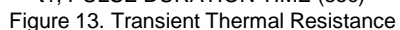


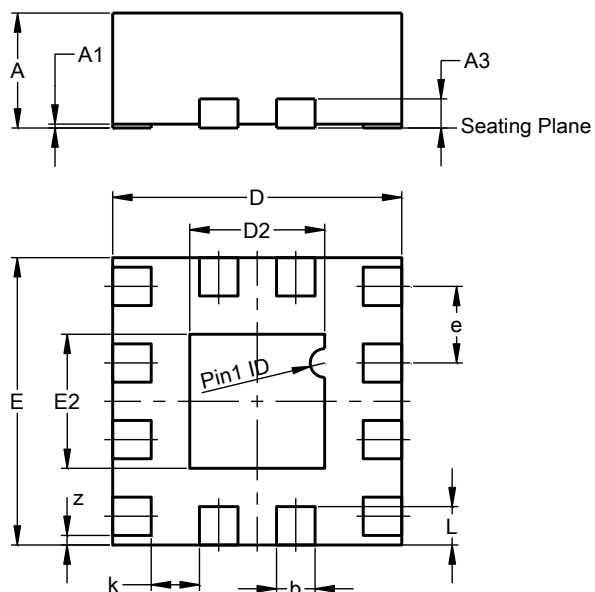
Figure 6. On-Resistance Variation with Temperature





Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

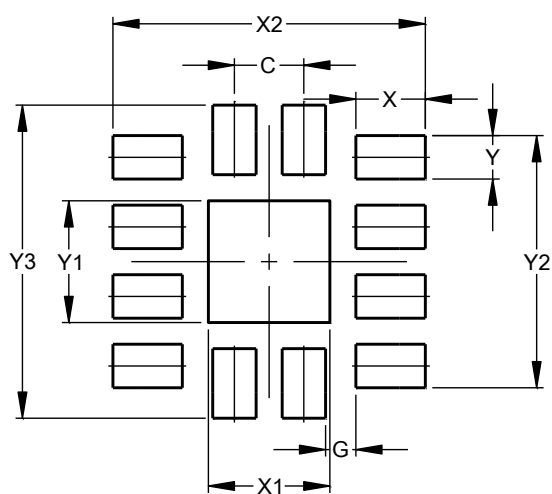
U-QFN1515-12



U-QFN1515-12			
Dim	Min	Max	Typ.
A	0.57	0.63	0.60
A1	0.00	0.05	0.02
A3	0.152 BSC		
b	0.15	0.25	0.20
D	1.45	1.55	1.50
D2	0.60	0.80	0.70
E	1.45	1.55	1.50
E2	0.60	0.80	0.70
e	0.40 BSC		
L	0.15	0.25	0.20
k	--	--	0.25
z	--	--	0.050
All Dimensions in mm			

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

U-QFN1515-12



Dimensions	Value (in mm)
C	0.400
G	0.175
X	0.400
X1	0.700
X2	1.800
Y	0.250
Y1	0.700
Y2	1.450
Y3	1.800

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